

BDX33B, BDX33C* (NPN) BDX34B, BDX34C* (PNP)

BDX33C and BDX34C are Preferred Devices

Darlington Complementary Silicon Power Transistors

These devices are designed for general purpose and low speed switching applications.

Features

- High DC Current Gain – $h_{FE} = 2500$ (typ.) at $I_C = 4.0$
- Collector–Emitter Sustaining Voltage at 100 mAdc
 $V_{CE(sus)} = 80$ Vdc (min) – BDX33B, BDX334B
 $= 100$ Vdc (min) – BDX33C, BDX334C
- Low Collector–Emitter Saturation Voltage
 $V_{CE(sat)} = 2.5$ Vdc (max) at $I_C = 3.0$ Adc
– BDX33B, 33C/34B, 34C
- Monolithic Construction with Build–In Base–Emitter Shunt Resistors
- Pb–Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage BDX33B, BDX34B BDX33C, BDX34C	V_{CEO}	80 100	Vdc
Collector–Base Voltage BDX33B, BDX34B BDX33C, BDX34C	V_{CB}	80 100	Vdc
Emitter–Base Voltage	V_{EB}	5.0	Vdc
Collector Current – Continuous – Peak	I_C	10 15	Adc
Base Current	I_B	0.25	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	70 0.56	W W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–65 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction–to–Case	$R_{\theta JC}$	1.78	$^\circ\text{C}/\text{W}$

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

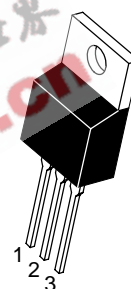
*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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**DARLINGTON
10 AMPERE
COMPLEMENTARY SILICON
POWER TRANSISTORS
80–100 VOLTS, 65 WATTS**



TO-220AB
CASE 221A-09
STYLE 1

MARKING DIAGRAM



BDX3xy = Device Code
x = 3 or 4
y = B or C
A = Assembly Location
Y = Year
WW = Work Week
G = Pb–Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

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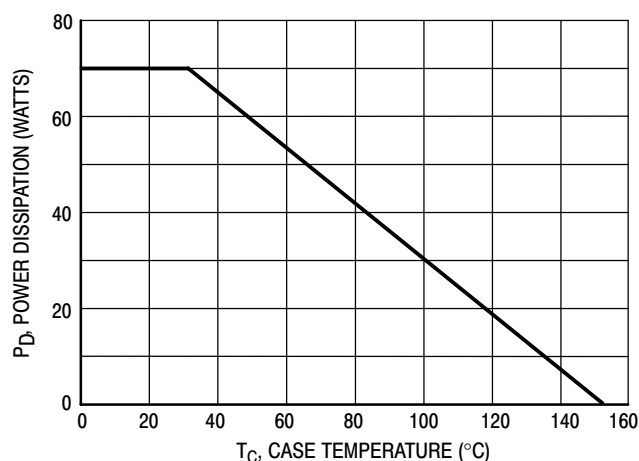


Figure 1. Power Derating

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Sustaining Voltage (Note 1) (I _C = 100 mAdc, I _B = 0)	BDX33B/BDX34B BDX33C/BDX34C V _{CEO(sus)}	80 100	– –	Vdc
Collector–Emitter Sustaining Voltage (Note 1) (I _C = 100 mAdc, I _B = 0, R _{BE} = 100)	BDX33B/BDX34B BDX33C/BDX33C V _{CER(sus)}	80 100	– –	Vdc
Collector–Emitter Sustaining Voltage (Note 1) (I _C = 100 mAdc, I _B = 0, V _{BE} = 1.5 Vdc)	BDX33B/BDX34B BDX33C/BDX34C V _{CEx(sus)}	80 100	– –	Vdc
Collector Cutoff Current (V _{CE} = 1/2 rated V _{CEO} , I _B = 0)	T _C = 25°C T _C = 100°C I _{CEO}	– –	0.5 10	mAdc
Collector Cutoff Current (V _{CB} = rated V _{CBO} , I _E = 0)	T _C = 25°C T _C = 100°C I _{CBO}	– –	1.0 5.0	mAdc
Emitter Cutoff Current (V _{BE} = 5.0 Vdc, I _C = 0)	I _{EBO}	–	10	mAdc
ON CHARACTERISTICS				
DC Current Gain (Note 1) (I _C = 3.0 Adc, V _{CE} = 3.0 Vdc)	BDX33B, 33C/34B, 34C h _{FE}	750	–	–
Collector–Emitter Saturation Voltage (I _C = 3.0 Adc, I _B = 6.0 mAdc)	BDX33B, 33C/34B, 34C V _{CE(sat)}	–	2.5	Vdc
Base–Emitter On Voltage (I _C = 3.0 Adc, V _{CE} = 3.0 Vdc)	BDX33B, 33C/34B, 34C V _{BE(on)}	–	2.5	Vdc
Diode Forward Voltage (I _C = 8.0 Adc)	V _F	–	4.0	Vdc

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.
2. Pulse Test non repetitive: Pulse Width = 0.25 seconds.

BDX33B, BDX33C* (NPN) BDX34B, BDX34C* (PNP)

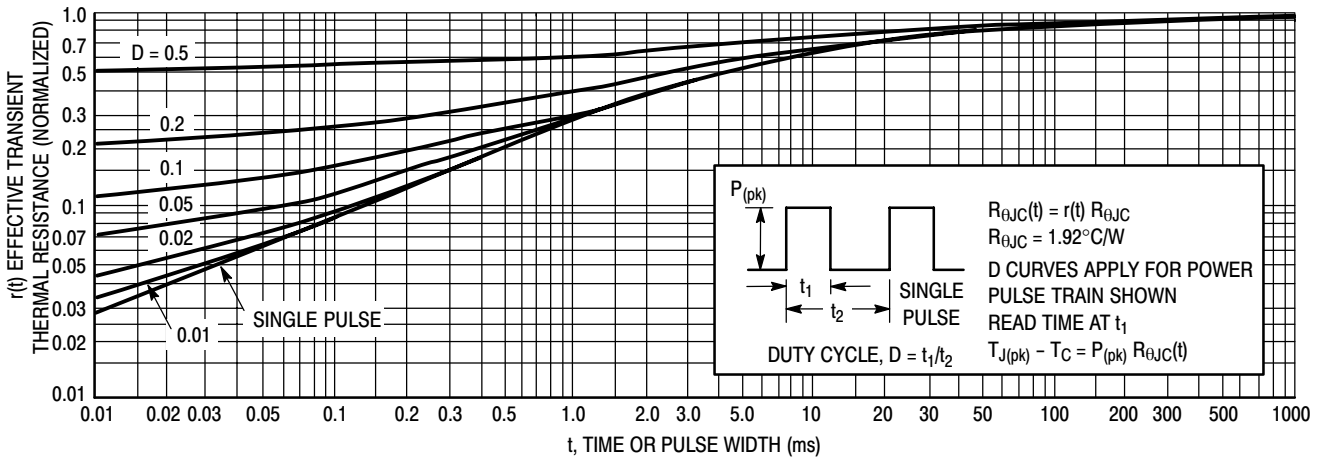


Figure 1. Thermal Response

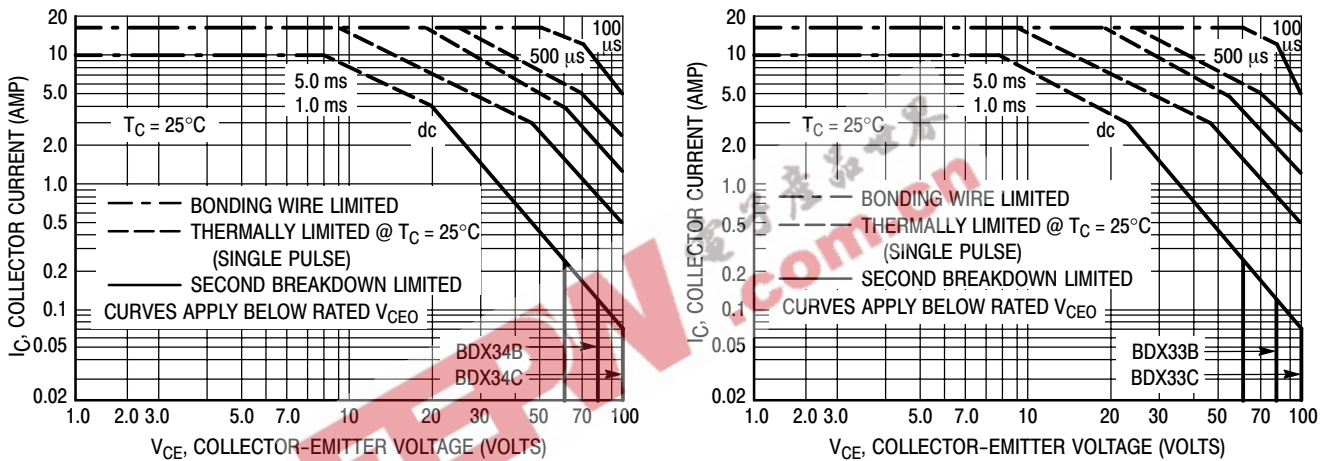


Figure 2. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 3 is based on $T_{J(pk)}$

$= 150^\circ\text{C}$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} = 150^\circ\text{C}$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

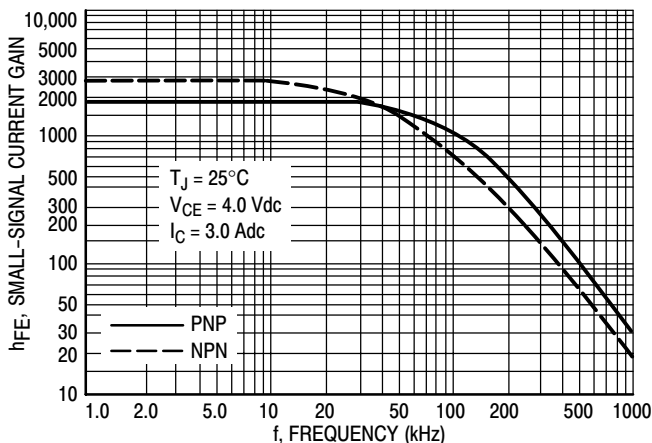


Figure 3. Small-Signal Current Gain

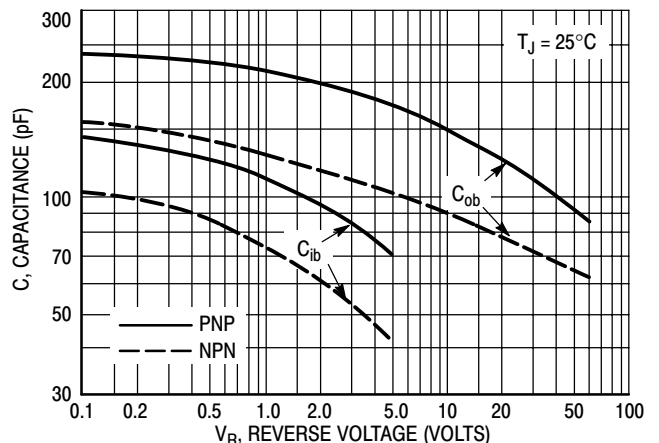


Figure 4. Capacitance

BDX33B, BDX33C* (NPN) BDX34B, BDX34C* (PNP)

NPN
BDX33B, 33C

PNP
BDX34B, 34C

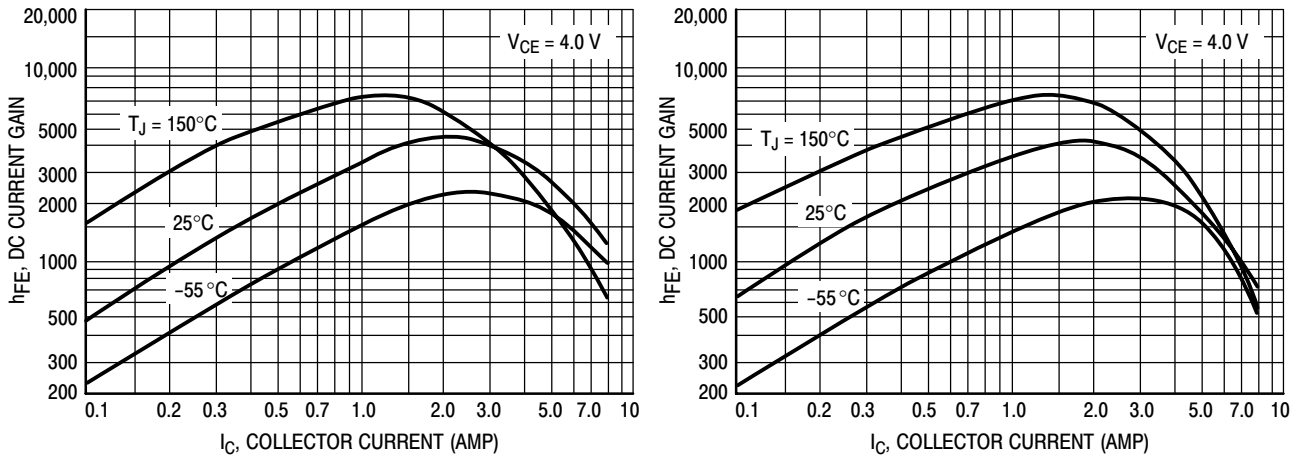


Figure 5. DC Current Gain

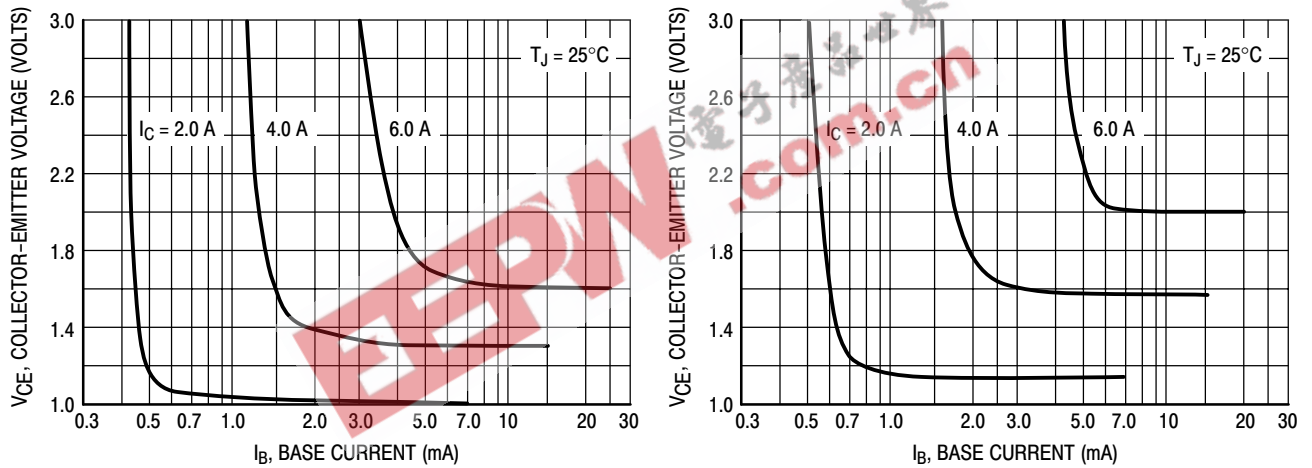


Figure 6. Collector Saturation Region

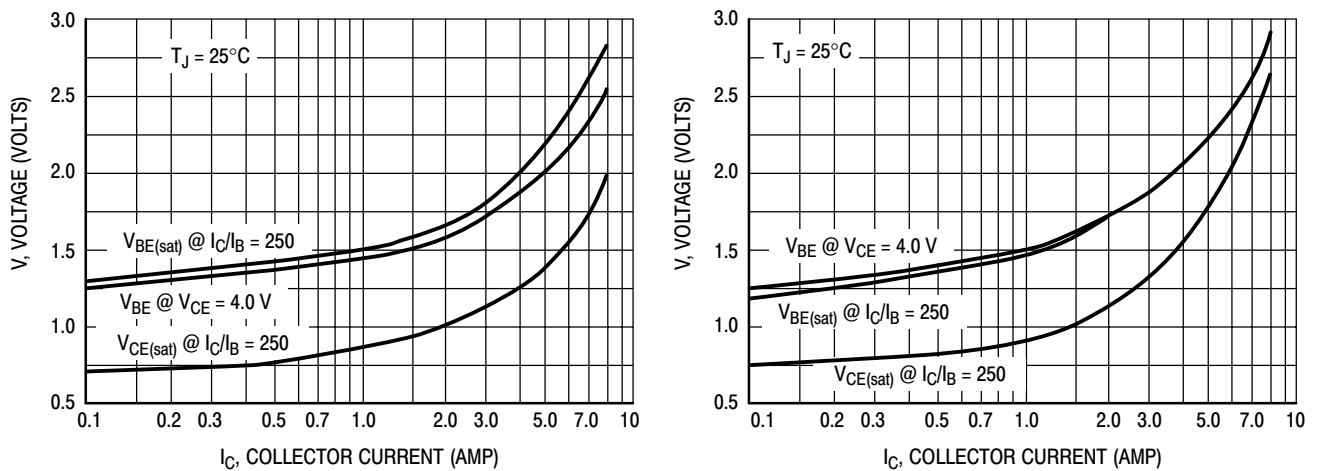


Figure 7. "On" Voltages

BDX33B, BDX33C* (NPN) BDX34B, BDX34C* (PNP)

ORDERING INFORMATION

Device	Package	Shipping†
BDX33B	TO-220	50 Units / Rail
BDX33BG	TO-220 (Pb-Free)	
BDX33C	TO-220	50 Units / Rail
BDX33CG	TO-220 (Pb-Free)	
BDX34B	TO-220	50 Units / Rail
BDX34BG	TO-220 (Pb-Free)	
BDX34C	TO-220	50 Units / Rail
BDX34CG	TO-220 (Pb-Free)	

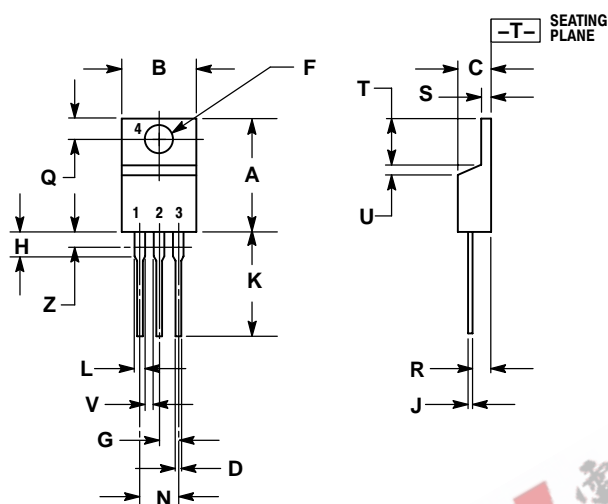
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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BDX33B, BDX33C* (NPN) BDX34B, BDX34C* (PNP)

PACKAGE DIMENSIONS

TO-220AB
CASE 221A-09
ISSUE AA




- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 1:

- PIN 1. BASE
- COLLECTOR
- EMITTER
- COLLECTOR

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